

03/26/01



J1042 U.S. PTO

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application of: Kie Y. Ahn et al.
Title: METHODS FOR MAKING COPPER AND OTHER METAL INTERCONNECTIONS IN INTEGRATED CIRCUITS

Attorney Docket No.: 303.459US2

JC929 U.S. PTO
09/817447

03/26/01

PATENT APPLICATION TRANSMITTAL

BOX PATENT APPLICATION

Commissioner for Patents
Washington, D.C. 20231

We are transmitting herewith the following attached items and information (as indicated with an "X"):

- ☒ Return postcard.
☒ **DIVISIONAL** of prior Patent Application No. 09/032,197 (under 37 CFR § 1.53(b)) comprising:
☒ Specification (18 pgs, including claims numbered 1 through 38 and a 1 page Abstract).
☒ Formal Drawing(s) (3 sheets).
☒ Copy of signed Declaration (6 pgs) from prior application.
☒ Copy of Power of Attorney from prior application (1 pg.)
☒ Incorporation by Reference: *The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied herewith, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.*
☒ Check in the amount of \$710.00 to pay the filing fee.
Prior application is assigned of record to Micron Technology, Inc.
Information Disclosure Statement (1 pgs), Form 1449 (9 pgs). References NOT enclosed, cited in prior application.
☒ Preliminary Amendment (1 pgs).

The filing fee has been calculated below as follows:

	No. Filed	No. Extra	Rate	Fee
TOTAL CLAIMS	1 - 20 =	0	x 18 =	\$0.00
INDEPENDENT CLAIMS	1 - 3 =	0	x 18 =	\$0.00
[] MULTIPLE DEPENDENT CLAIMS PRESENTED				\$0.00
BASIC FEE				\$710.00
TOTAL				\$710.00

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This paper or fee is being deposited on the date indicated above with the United States Postal Service pursuant to 37 CFR 1.10, and is addressed to
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